



# SLD15N04T 40V N -Channel MOSFET

#### **General Description**

This Power MOSFET is produced using Msemitek's advanced TRENCH technology.

This advanced technology has been especially tailored to minimize conduction loss, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

#### Application

☑PWM Application

☑Power Management

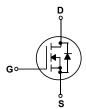
#### **Features**

- N-Channel:40V 15A

 $R_{DS(on)Typ} = 15.5 \text{m}\Omega @VGS = 10 \text{ V}$  $R_{DS(on)Typ} = 20.8 \text{m}\Omega @VGS = 4.5 \text{ V}$ 

- Very Low On-resistance  $R_{\text{DS}(\text{ON})}$
- Low Crss
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability





# **Absolute Maximum Ratings** T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	SLD15N04T	Units
$V_{DSS}$	Drain-Source Voltage	40	V
ı	Drain Current - Continuous (T <sub>C</sub> = 25°C)	15	Α
l <sub>D</sub>	- Continuous (T <sub>C</sub> = 100°C)	10.5	Α
$I_{DM}$	Drain Current - Pulsed (Note 1)	60	Α
$V_{GSS}$	Gate-Source Voltage	±20	V
Eas	Single Pulsed Avalanche Energy (Note 2)	25	mJ
P <sub>D</sub>	Power Dissipation (T <sub>C</sub> = 25°C)	31	W
R <sub>0JA</sub>	Thermal Resistance, Junction to Case	4	°C/W
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150	င
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300	င

<sup>\*</sup> Drain current limited by maximum junction temperature.

## **Package Marking**

Part Number	Top Marking	Package	Packing Method	MOQ	QTY
SLD15N04T	SLD15N04T	D-PAK	Tape & Reel	2500	25000

#### **Electrical Characteristics**

T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Characteristics						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 uA	40			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =40 V, V <sub>GS</sub> = 0 V			1	uA
Igssf	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 20V, V <sub>DS</sub> = 0 V			100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	V <sub>GS</sub> = -20 V, V <sub>DS</sub> = 0 V			-100	nA

#### **On Characteristics**

	$V_{\text{GS(th)}}$	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 uA	1.0	1.6	2.2	V
	R <sub>DS(on)</sub>	Static Drain-Source	V <sub>GS</sub> =10 V, I <sub>D</sub> = 8A	15.5	21	mΩ	
		On-Resistance	V <sub>GS</sub> =4.5 V, I <sub>D</sub> = 4A		20.8	28	11122

### **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V, f = 1.0 MHz	-	750	1	pF
Coss	Output Capacitance		1	61	1	pF
$C_{rss}$	Reverse Transfer Capacitance			49	-	рF

### **Switching Characteristics**

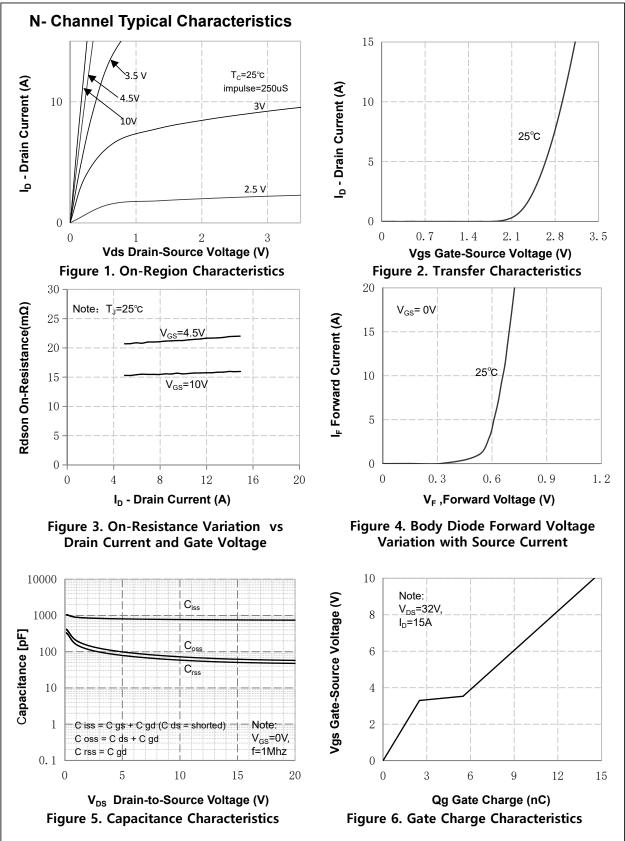
$t_{d(on)}$	Turn-On Delay Time			11		ns
tr	Turn-On Rise Time	$V_{GS}=10V, V_{DS}=20V,$ $R_{L}=3\Omega, I_{D}=10A$ (Note 3)	-	13		ns
$t_{d(off)}$	Turn-Off Delay Time		-	36	1	ns
t <sub>f</sub>	Turn-Off Fall Time	` '	-	9	-	ns
$Q_g$	Total Gate Charge	V <sub>DS</sub> =32V, I <sub>D</sub> =15A,	-	14.5	-	nC
Qgs	Gate-Source Charge	$V_{GS} = 10V$ (Note 3)	-	2.5	-	nC
$Q_{gd}$	Gate-Drain Charge		-	3.0		nC
$R_G$	Gate Resistance	f = 1MHz		4.0		Ω

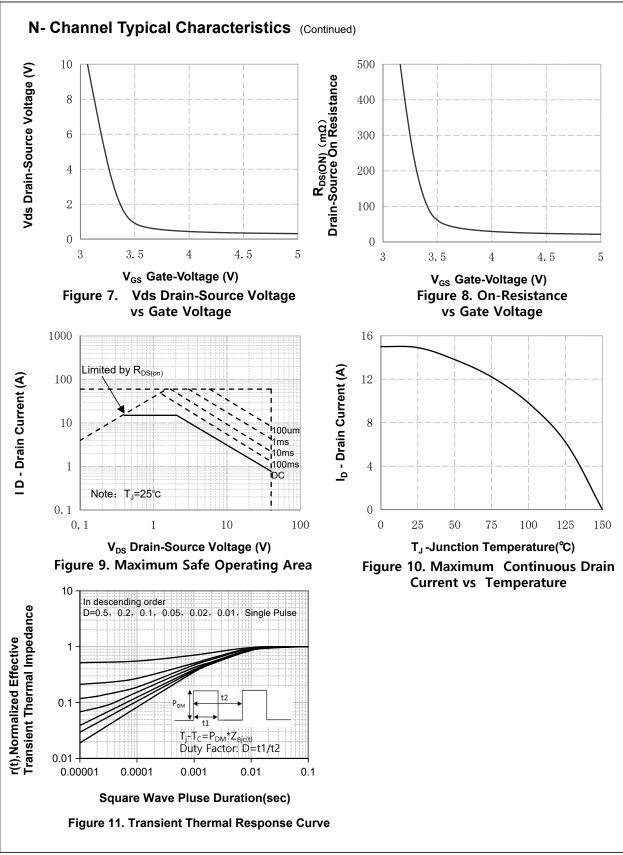
### **Drain-Source Diode Characteristics and Maximum Ratings**

Is	Maximum Continuous Drain-Source Diode Forward Current	-	 15	Α
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current	-	 60	Α
V <sub>SD</sub>	Drain to Source Diode Forward Voltage, V <sub>GS</sub> = 0V, I <sub>SD</sub> = 10A, T <sub>J</sub> = 25°C		 1.2	V

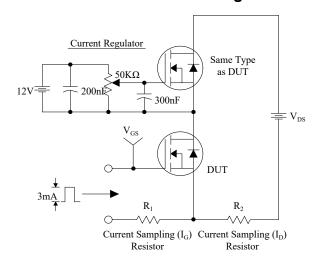
#### Notes:

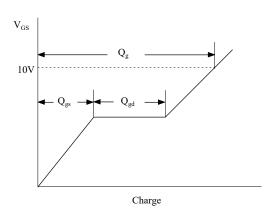
- 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
- 2. EAS condition: T  $_J$  =25°C, V  $_{DD}$  =30V, V  $_G$  =10V,L=0.5mH.
- 3. Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%



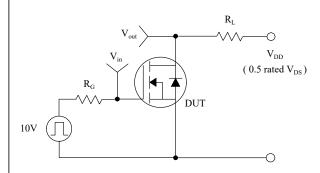


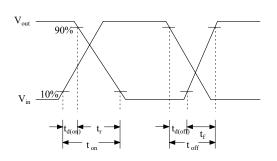
## **Gate Charge Test Circuit & Waveform**



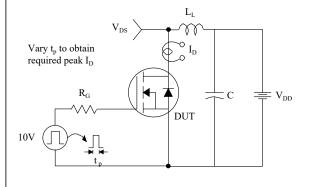


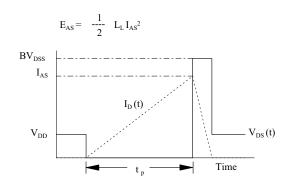
# **Resistive Switching Test Circuit & Waveforms**



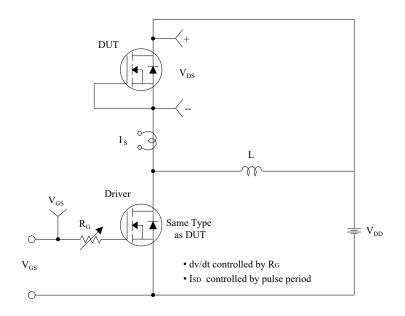


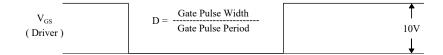
# **Unclamped Inductive Switching Test Circuit & Waveforms**

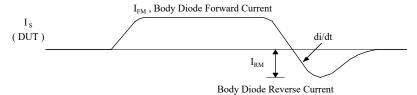


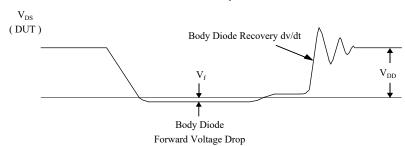


# Peak Diode Recovery dv/dt Test Circuit & Waveforms

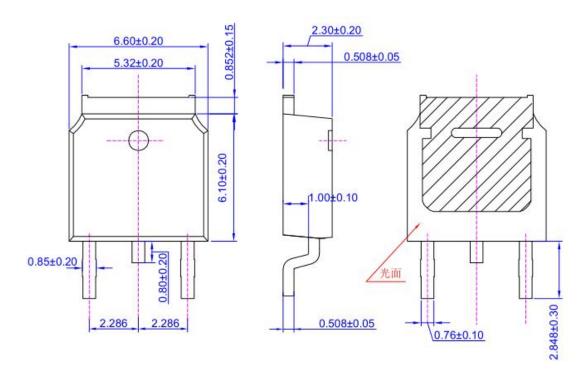


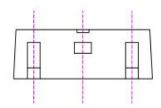






### **TO-252 OUTLINE**





### NOTE:

1The plastic package is not marked as smooth surfaceRa=0.1;Subglossy surfaceRa=0.8 2.Undeclared tolerance  $\pm$  0.25,Unmarked filletRmax=0.25

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